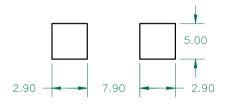
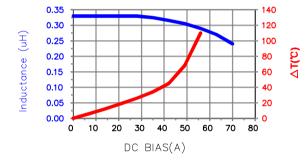
MGV1203R33M-10

PHYSICAL DIMENSIONS:

A 13.50 ± 0.50 B 12.60 ± 0.30 C 3.50 ± 0.30 D 3.60 ± 0.50 E 2.30 ± 0.50

LAND PATTERNS FOR REFLOW SOLDERING

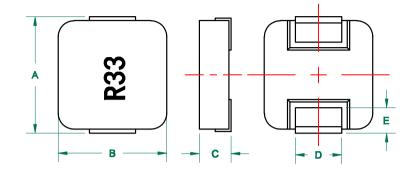




ELECTRICAL SPECIFICATION @ 25°C

	Min	Nom	Max	
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	0.264	0.33	0.396	
DCR (Ω)			0.0015	

Saturation Current ³ Isat (A)	62.00
Temperature Rise Current Irms ⁴ (A)	36.50









NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE:
 - -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.SATURATION CURRENT Isat IS DEFINED AS MAXIMUM AMOUNT OF CURRENT BY WHICH INDUCTANCE WILL DROP BY TYPICAL VALUE OF 25% OF INITIAL INDUCTANCE (Ta=25±5°C).
- 4.TEMPERATURE RISE CURRENT (Irms): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

	DIMENSIONS ARE IN mm.			This print is the property of Laird					
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F	EV	DESCRIPTION	DATE	INT	MGV1203R33M-10-A	,	_	1	of 1